

S29GL256P11WEI019 Information


For Reference Only

Part Number [S29GL256P11WEI019](#)
Manufacturer Cypress Semiconductor Corp
Category Integrated Circuits (ICs)
[Memory](#)
Description IC FLASH 256M PARALLEL WAFER
Package Die
 For the pricing/inventory/lead time, please contact us
 Website: <https://www.heisener.com>
 E-mail: salesdept@heisener.com


[Request a Quote](#)
Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.


S29GL256P11WEI019 Specifications

Manufacturer Part Number	S29GL256P11WEI019
Manufacturer	Cypress Semiconductor Corp
Category	Integrated Circuits (ICs) Memory
Package	Die
Series	GL-P
Memory Type	Non-Volatile
Memory Format	FLASH
Technology	FLASH - NOR
Memory Size	256Mb (32M x 8)
Memory Interface	Parallel
Clock Frequency	-
Write Cycle Time - Word, Page	110ns
Access Time	110ns
Voltage - Supply	2.7 V ~ 3.6 V
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	Die
Supplier Device Package	Wafer

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S29GL256P11WEI019 Guarantees



Quality Guarantees

We provide 90 days warranty. *

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



Service Guarantees

We guarantee 100% customer satisfaction.

Our experienced sales team and tech support team back our services to satisfy all our customers.

S29GL256P11WEI019 Payment Methods



S29GL256P11WEI019 Shipping Methods



If you have any question about S29GL256P11WEI019, please do not hesitate to contact us!

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